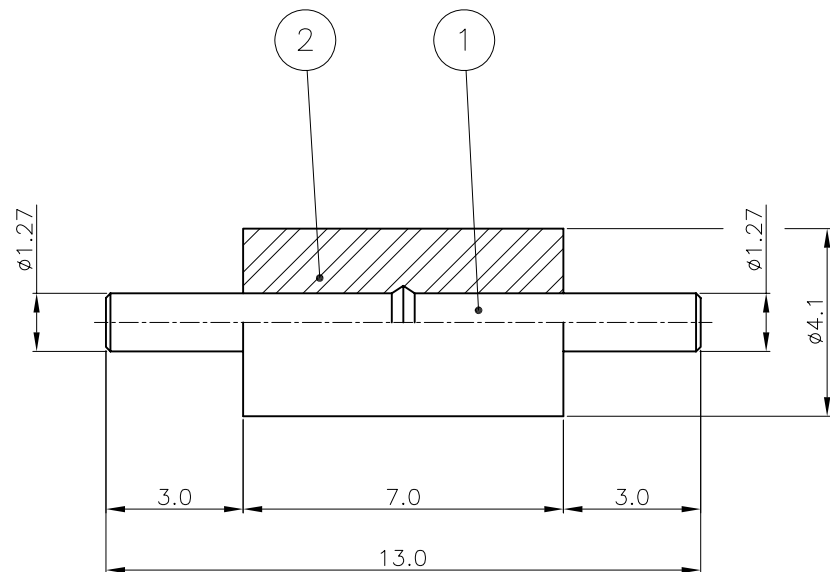
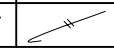




REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM	I.C.KIM	2012.09.19.
1	[설변처리No.201210-0001] 절연체 ,PIN 구조 및 치수 변경	I.C.KIM	I.C.KIM	2012.10.08.

2	INSULATOR	1	TEFLON		DIN02069-N/1
1	CONTACT	1	MBsBD	Gold Plate	DCT02670-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2012. 10. 08.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE BUSHING SOLDER END
		DRAWN BY	I.C.KIM	
FINISH		SCALE 6/1	UNIT mm	
		A4	DWG NO. CN02860-7/1	
		REVISION 1	SHEET 1 of 1	